

Meeting Date/Time: 19.09.2022 / 11:00

Participants: SCAI, HTW Berlin, DLR (Institute of Composite Structures and Adaptive Systems), BETA CAE, BAM,

Agenda:

1. Presentation by DLR Martin Rädcl

COMPLETE MODEL STORAGE – A SOLVER-AGNOSTIC HIERARCHICAL APPROACH

Problem: need to provide dedicated models for each solver

Tasks: transfer of data in an integrated CAE workflow

Approach: Hierarchy of descriptions Mathematics - Physics - Mechanical

- numerical Model

Goal: expandable and modular for materials and load cases and ...

Implementation: using VMAP for heavy data and jMeS for 'light data' and VMAP2XDMF converter for ParaView

Ontology to describe relations

Light data needs to be solver independent

Geometry; CSM; Loads and BCs; MPCs; solutions

Output through serialisation lib to JSON,XML, YAML

Still many solver dependent parameters and definitions - stored as additional code info

Transforming code-internal-code formats works for many features for a number of codes (ready to run)

Unified postprocessing by paraview

Shared infos: parts on their way to be open source; examples can be shared directly

2. Discussion

DLR and HTW already had a bilateral meeting

Differentiation:

description of file formats - in discussions

no model creation in here

SMILE deals much more with modelling

DLR could provide (intermediate) formats between SMILE and the native solvers

How are models created now?

(external) model generators

import from existing models in native solvers

Extendability

adapting JAVA objects plus XML

2. Feedback regarding the integration of VMAP & SMILE

Based on the slides presented by HTW in the last meeting there was a detailed discussion regarding the integration of VMAP & SMILE.

There is a general majority on integrating the two, however, the method and goals need to be clearly defined.

Whether the purpose of this integration is a just a tool independent description of the model or abstract representation

of an entity. There were many questions raised in the meeting regarding the implementation/extension of VMAP

to support components of a CAE Mode like MPCs, weld spots, etc.

3. Next Meeting is planned for Monday October 17, 2022 at 11:30
Feedback from NAFEMS DACH Workshop (hybrid workshop for VMAP partners,
distrb
DLR Oliver Kunc